## RENESAS

# MOS FIELD EFFECT TRANSISTOR 2SK3484

## SWITCHING N-CHANNEL POWER MOS FET

#### DESCRIPTION

The 2SK3484 is N-channel MOS Field Effect Transistor designed for high current switching applications.

#### FEATURES

- Low on-state resistance  $R_{DS(on)1} = 125 \text{ m}\Omega \text{ MAX. (Vgs} = 10 \text{ V, Id} = 8 \text{ A)}$
- $R_{DS(on)2} = 148 \text{ m}\Omega \text{ MAX.} (V_{GS} = 4.5 \text{ V}, \text{ ID} = 8 \text{ A})$
- Low Ciss: Ciss = 900 pF TYP.
- Built-in gate protection diode
- TO-251/TO-252 package

#### ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Drain to Source Voltage (Vgs = 0 V)	VDSS	100	V
Gate to Source Voltage ( $V_{DS} = 0 V$ )	Vgss	±20	V
Drain Current (DC) (Tc = 25°C)	D(DC)	±16	А
Drain Current (pulse) Note1	D(pulse)	±22	А
Total Power Dissipation (Tc = 25°C)	PT1	30	W
Total Power Dissipation ( $T_A = 25^{\circ}C$ )	P <sub>T2</sub>	1.0	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55 to +150	°C
Single Avalanche Current Note2	las	10	А
Single Avalanche Energy Note2	Eas	10	mJ

#### **ORDERING INFORMATION**

PART NUMBER	PACKAGE	
2SK3484	TO-251 (MP-3)	
2SK3484-Z	TO-252 (MP-3Z)	

(TO-251)



(TO-252)



Notes 1.  $PW \le 10 \ \mu s$ ,  $Duty \ Cycle \le 1\%$ 

**2.** Starting T<sub>ch</sub> = 25°C, V<sub>DD</sub> = 50 V, R<sub>G</sub> = 25  $\Omega$ , V<sub>GS</sub> = 20  $\rightarrow$  0 V

#### THERMAL RESISTANCE

Channel to Case Thermal Resistance	Rth(ch-C)	4.17	°C/W
Channel to Ambient Thermal Resistance	Rth(ch-A)	125	°C/W

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The mark <R> shows major revised points.

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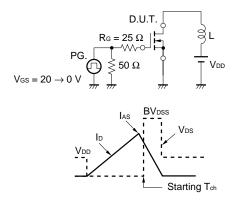
ELECTRICAL CHARACTERISTICS (TA = 25°C)

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	IDSS	Vds = 100 V, Vgs = 0 V			10	μA
Gate Leakage Current	lgss	$V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			±10	μA
Gate Cut-off Voltage	VGS(off)	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA	1.5	2.0	2.5	V
Forward Transfer Admittance Note	y <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 8 A	4.7	9.5		S
Drain to Source On-state Resistance Note	RDS(on)1	Vgs = 10 V, Id = 8 A		100	125	mΩ
	RDS(on)2	Vgs = 4.5 V, Id = 8 A		110	148	mΩ
Input Capacitance	Ciss	V <sub>DS</sub> = 10 V		900		pF
Output Capacitance	Coss	V <sub>GS</sub> = 0 V		110		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		50		pF
Turn-on Delay Time	td(on)	Vdd = 50 V, Id = 8 A		9.0		ns
Rise Time	tr	V <sub>GS</sub> = 10 V		5.0		ns
Turn-off Delay Time	td(off)	$R_G = 0 \Omega$		30		ns
Fall Time	tr			4.0		ns
Total Gate Charge	QG	V <sub>DD</sub> = 80 V		20		nC
Gate to Source Charge	QGS	V <sub>GS</sub> = 10 V		3.0		nC
Gate to Drain Charge	Qgd	ID = 16 A		5.0		nC
Body Diode Forward Voltage Note	VF(S-D)	IF = 16 A, VGS = 0 V		1.0		V
Reverse Recovery Time	trr	IF = 16 A, VGS = 0 V		60		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/ μs		122		nC

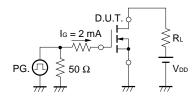
Note Pulsed

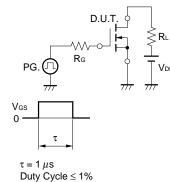
#### TEST CIRCUIT 1 AVALANCHE CAPABILITY

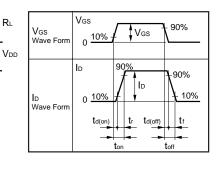
#### **TEST CIRCUIT 2 SWITCHING TIME**



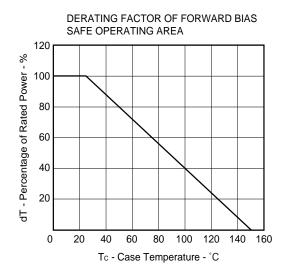
#### TEST CIRCUIT 3 GATE CHARGE



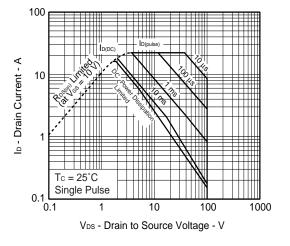


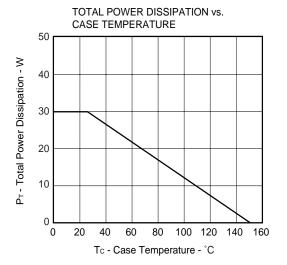


### TYPICAL CHARACTERISTICS ( $T_A = 25^{\circ}C$ )

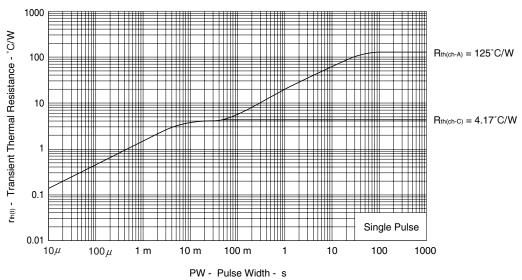






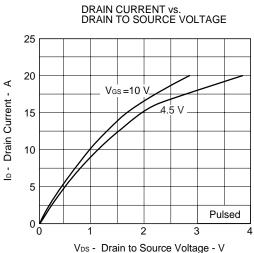


TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

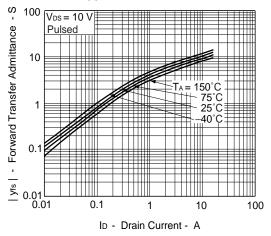


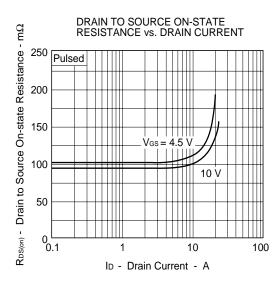
100 Pulsed  $V_{DS} = 10 V$ Ip - Drain Current - A 10  $T_A = -40^{\circ}C$ 1 25°C 75°C 150°C 0.1 0.01 5 2 3 4 1 VGS - Gate to Source Voltage - V

FORWARD TRANSFER CHARACTERISTICS

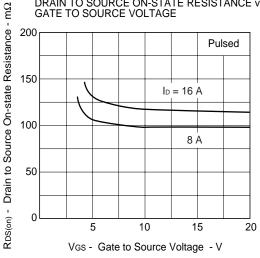


FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT

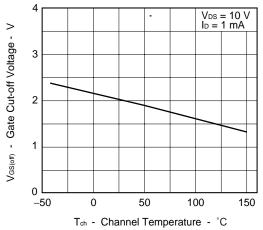


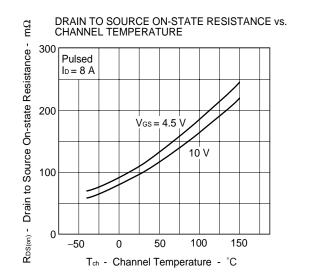


DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE









CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE

⊕

1

VDS - Drain to Source Voltage - V

Π

0.1

NEC

10000

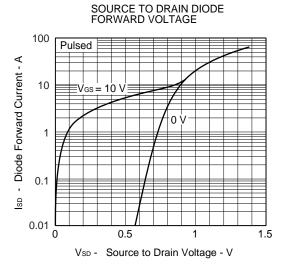
1000

100

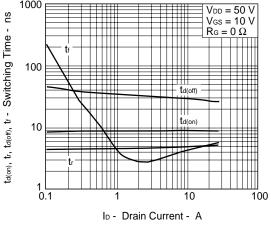
10

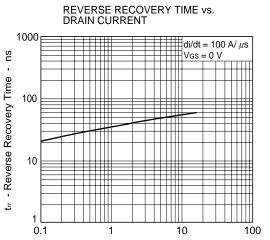
0.01

Ciss, Coss, Crss - Capacitance - pF



SWITCHING CHARACTERISTICS 1000





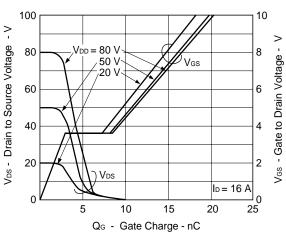
IF - Drain Current - A

Crss

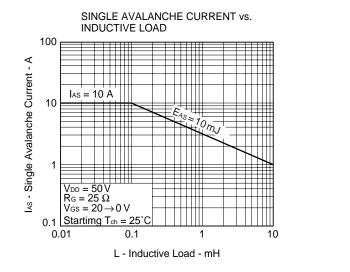
100

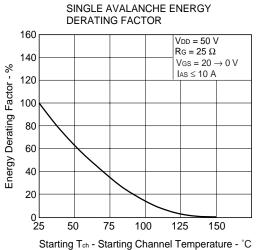
V<sub>GS</sub> = 0 V f = 1 MHz

10

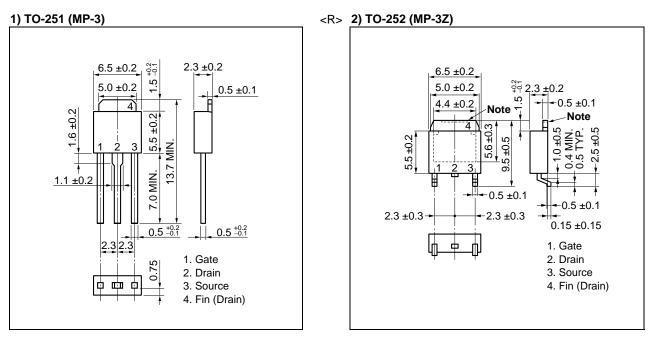


DYNAMIC INPUT/OUTPUT CHARACTERISTICS



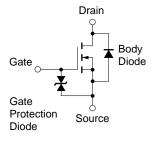


#### PACKAGE DRAWINGS (Unit: mm)



**Note** The depth of notch at the top of the fin is from 0 to 0.2 mm.

#### **EQUIVALENT CIRCUIT**



**Remark** The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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